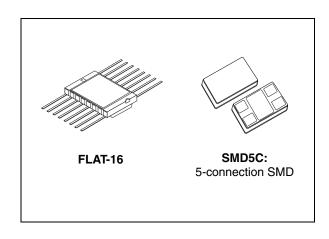


RHFL7913A

Rad-hard adjustable negative voltage regulator

Features

- 3 A low dropout voltage
- Optional overtemperature and overcurrent protection
- Adjustable overcurrent limitation
- Load short circuit monitoring
- Adjustable output voltage
- Inhibit (ON/OFF) TTL-compatible control
- Programmable output short-circuit current limitation
- Remote sensing operation
- Rad-hard: sustains 300 krad in Mil-1019.7 at High & ELDRS low dose rate conditions
- Heavy ions, SEL immune at 68 MeV/cm²/mg LET ions; able to Sustains 2x10¹⁴ protons/cm²



Description

The RHFL7913A adjustable is a high performance Rad hard negative voltage regulator. Available in FLAT-16 and new SMD5C hermetic ceramic packages, it is specifically intended for space and harsh radiation environments. It provides exceptional electrical performances, high speed and low dropout voltage.

Input supply ranges from -3 V to -12 V. It also provide logical control / monitor functions (inhibit, output monitor, short-circuit control) from/to external positive voltage signals, while the entire RHFL7913A adjustable analog functions are biased at negative voltages with respect of ground pin. The device is QML-V qualified with SMD 5962-02532.

Contents RHFL7913A

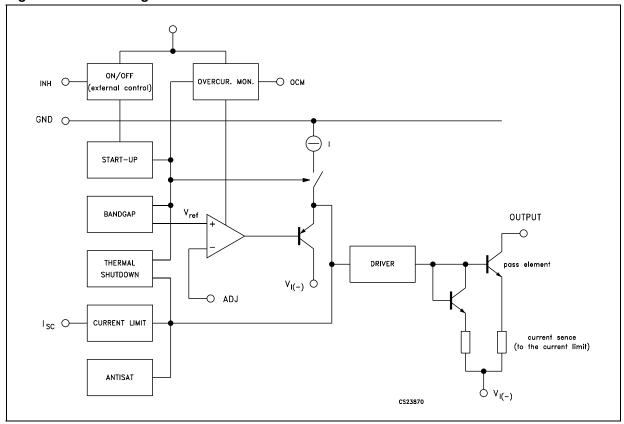
Contents

1	Diagram		 	 3
2	Pin configuration		 	 4
3	Maximum ratings		 	 5
4	Electrical characte	eristics	 	 6
5	Device description	۱	 	 8
	5.1 ADJ pin		 	 8
	5.2 Inhibit ON-OF	F control	 	 8
	5.3 Overtemperat	ure protection	 	 8
	5.4 Overcurrent p	rotection	 	 8
	5.5 OCM pin		 	 8
	5.6 Alternates to		 	 9
6	Application inform	nation	 	 10
	6.1 Remote sensi	ng operation	 	 11
7	Die information .		 	 12
8	Package mechanic	cal data	 	 13
9	Packaging		 	 16
10	Order codes		 	 17
11	Revision history		 	 18

RHFL7913A Diagram

1 Diagram

Figure 1. Block diagram



Pin configuration RHFL7913A

2 Pin configuration

Figure 2. Pin configuration (top view for FLAT-16, bottom view for SMD5C)

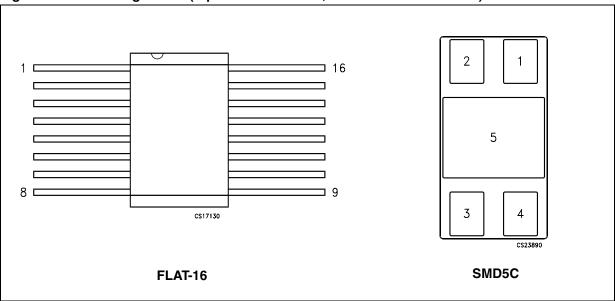


Table 1. Pin description

Pin n°	FLAT-16	SMD5C
DSCC Part Ident.	5962-02532	5962-02532
1	V _I , Negative Input	V _I , Negative Input
2	V _I , Negative Input	V _I , Negative Output
3	V _I , Negative Input	ADJ
4	I _{sc}	Inhibit
5	OCM	GND
6	V _{PLUS} , Positive Supply	
7	GND	
8	N.C.	
9	N.C.	
10	GND	
11	Inhibit	
12	ADJ	
13	N.C.	
14	V _O , Negative Output	
15	V _O , Negative Output	
16	V _O , Negative Output	

RHFL7913A Maximum ratings

3 Maximum ratings

Table 2. Maximum operating ratings (1)

Symbol	Pa	Value	Unit		
VI	DC input voltage IV _{IN} – V _{PLUS} I		-12		
V _{PLUS}	Logical block supply voltage V(+)	-V(GND), unless grounded	+5		
VI	DC voltage, V _{IN} -GND, V _{PLUS} = 0\	1	-12	V	
VI	DC voltage, V _{IN} -GND, V _{PLUS} =+3	V	-9		
V _O	DC output voltage range		-9 to -1.20		
lour	Outrout surrent	RHFL7913KPA	RHFL7913KPA	2	Α
Гоит	Output current	RHFL7913SCA	3	7	
P _D	TC = 25 °C power dissipation	RHFL7913KPA	15	w	
. 0	10 = 25 °C power dissipation	RHFL7913SCA	15	•	
T _{STG}	Storage temperature range		-65 to +150	°C	
T _{OP}	Operating junction temperature range		-55 to +150		
ESD	Electrostatic discharge capability		Class 3		

Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thJC}	Thermal resistance junction-case, FLAT-16 and SMD5C	8.3	°C/W
T _{SOLD}	Maximum soldering temperature, 10 sec.	300	°C

Table 4. Recommended operating conditions

Symbol	Parameter		Value	Unit
V _I	Input voltage range V _I (at V _{PLUS} = 0V)		-12 to -1.3	V
V _{PLUS}	Positive supply range		0 to +3	V
V _O	Output voltage range	V_{PLUS} =0V, V_{I} = -12 to -3.7V	-9.5 to -1.2	V
٧٥	Output voltage range	V_{PLUS} =+3V, V_{I} = -9 to -3.7V	-6.5 to -1.2	V
T _A	Ambient operating temperatur	-55 to +125	°C	

Electrical characteristics RHFL7913A

4 Electrical characteristics

Table 5. Electrical characteristics (T_J = 25 °C, V_I = V_O+2.5 V, C_I = C_O = 1 μ F, unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
VI	Operating input voltage	I _O = 1A (KPA) or 2A (SCA)	-12			٧
		I _O = 1A, V _O = -1.2V, FLAT 16	-1.28		-1.16	
.,	Operating output	I _O = 1A, V _O = -9V, FLAT 16	-9.6		-8.7	V
V _O	voltage	I _O = 2A, V _O = -1.2V, SMD5C	-1.28		-1.16	V
		I _O = 2A, V _O = -9V, SMD5C	-9.6		-8.7	
AV JAV	Line regulation	$V_I = V_O - 2.5V \text{ to -12V}, I_O = 5\text{mA},$ $T_J = 25^{\circ}\text{C}$			0.2	
Δνο/Δν	Line regulation	$V_I = V_O - 2.5V \text{ to } -12V, I_O = 5\text{mA},$ $T_J = -55^{\circ}\text{C} \text{ and } +125^{\circ}\text{C}$			0.5	
		$V_I = V_O - 2.5V$, $I_O = 5mA$ to 400mA, $T_J = 25$ °C			0.4	%
ΔV _O /V _O	Load regulation	$V_I = V_O - 2.5V$, $I_O = 5mA$ to 400mA $T_J = -55^{\circ}C$ and $+125^{\circ}C$			0.5	
		$V_I = V_O - 2.5V$, $I_O = -5mA$ to 1A, $T_J = 25^{\circ}C$			0.5	
		$V_I = V_O - 2.5V$, $I_O = 5mA$ to 1A, $T_J = -55^{\circ}C$ and $+125^{\circ}C$			0.6	
		$I_{O} = 5$ mA, $V_{I} = V_{O}$ -2.5V, $T_{J} = 25$ °C	-3			
		I_{O} =-30mA, V_{I} = V_{O} -2.5V, T_{J} = 25°C	-6			
		$I_{O} = 300$ mA $V_{I} = V_{O} - 2.5$ V, $T_{J} = 25$ °C and $+125$ °C	-15			
		$I_{O} = 300$ mA $V_{I} = V_{O} - 2.5$ V, $T_{J} = -55$ °C	-20			
IQ	Quiescent current ON MODE	$I_O = 1A V_I = V_O -2.5V,$ $T_J = 25^{\circ}C$ and +125°C	-30			mA
		$I_{O} = 1 \text{A V}_{I} = V_{O} - 2.5 \text{V}, T_{J} = -55 ^{\circ} \text{C}$	-50			
		$I_O = 3A V_I = V_O -2.5V, V_{INH} = 0,$ $T_J = +25^{\circ}C \text{ and } +125^{\circ}C \text{ Only for SMD5C}$	-90			
		$I_O = 2A V_I = V_O -2.5V$, $V_{INH} = 0$, $T_J = -55$ °C Only for SMD5C,	TBD			
IQ	Quiescent current OFF MODE	$V_O = -1.2V$, $V_I = -7V$, $V_{PLUS} = +5V$, $V_{INH} > 2.3V$, $T_J = -55^{\circ}C$ to $+125^{\circ}C$			1	mA

Table 5. Electrical characteristics (continued) $(T_J = 25 \ ^{\circ}C, \ V_I = V_O + 2.5 \ V, \ C_I = C_O = 1 \ \mu F, \ unless \ otherwise \ specified)$

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
		$I_O = 400$ mA $V_O = -2.5$ V to -9 V, $T_J = 25$ °C	-450			mV	
.,	Dropout valtage	$I_O = 400$ mA $V_O = -2.5$ V to -9V, $T_J = -55$ °C and +125°C	-500				
V _D	Dropout voltage	$I_O = 1A V_O = -2.5V \text{ to } -9V, T_J = 25^{\circ}C$	-750				
		$I_O = 1A V_O = -2.5V \text{ to -9V},$ $T_J = -55^{\circ}\text{C} \text{ and } +125^{\circ}\text{C}$	-800				
I _{PLUS} (1)	(1) V _{PLUS} Current	$V_{I} = -5.5V, V_{PLUS} = 5V, V_{INH} = 5V,$ $T_{J} = 25^{\circ}C$			0.75	A	
		V_{I} = -5.5V, V_{PLUS} = +5V, V_{INH} = 5V T_{J} = -55°C and +125°C			1	- mA	
SVR (1)	Supply voltage	$V_I = V_O - 2.5V$, $I_O = 5mA$, $F = 120Hz$	60			- dB	
SVR	rejection	$V_1 = V_O - 2.5V$, $I_O = 5mA$, $F = 33kHz$	20			ub	
t _{PLH} (1)	Inhibit propagation delay	$V_{INH} < 0.8V$, $V_{PLUS} = 5V$, $V_{I} = V_{O}$ -2.5V $I_{O} = 400$ mA			20		
t _{PHL} ⁽¹⁾	Inhibit propagation delay	V_{INH} >2.3V, V_{PLUS} = 5V, V_{I} = V_{O} -2.5V I_{O} = 400mA			100 µs		
V _{INH(ON)}	Inhibit voltage	$V_I = -7V V_{PLUS} = +5V I_O = 5mA$			0.8	V	
V _{INH(OFF)}	Tillibit voltage	T _J = -55°C to 125°C	2.3			, v	
I _{SH}	Shutdown input current	V _{INH} =5V		15		μΑ	
V _{OCM}	OCM pin voltage	Sinked I _{OCM} = 10mA, active low		0.38		V	
en	Output noise voltage	$f = 10Hz$ to 100kHz $I_O = 5mA$ to 2A		40		μVrms	

^{1.} These values are guaranteed by design. For each application it's strongly recommended to comply with the maximum current limit of the package used.

57

Device description RHFL7913A

5 Device description

The RHFL7913A adjustable contains a NPN-type power element controlled by signal resulting from amplified comparison between internal temperature compensated band-gap cell and the fraction of the desired output voltage value, generated by an external resistor divider bridge. The NPN structure allows access to lower drop out levels because its base current can be routed to ground pin and not to output. To control and monitor the device from / to the external logic world – usually operating in positive voltage area – a dedicated logic interface block (INHIBIT and OCM functions) has been implemented with +3 V to +5 V supplied line V(+). In case V(+) = 0 V, inhibit and OCM functions are not available: In this condition, INHIBIT function is ON and OCM pin is "no care". The device is internally protected by several blocks.

5.1 ADJ pin

The load voltage feed back comes from an external divider resistor bridge middle point to ADJ pin established between load terminals.

5.2 Inhibit ON-OFF control

When INHIBIT pin is TTL-high (positive), the device switches off current and voltage output. The device is ON when INHIBIT pin is set TTL-low.

5.3 Overtemperature protection

A temperature detector internally monitors power element junction temperature. The device goes OFF circa 165 °-175 °C are reached, and returns ON when circa 100 °C. When internal temperature detector reaches 170 °C, the active power element can be at 225 °C: Device reliability cannot be granted during extensive operation duration with these conditions.

5.4 Overcurrent protection

 I_{SC} pin. An internal non-fold back short-circuit limitation is set with $I_{SHORT} > 4$ A (V_O is 0 V). This value can be downward modified by an external resistor connected between I_{SC} and V_I pins, with a typical value range of 10 k Ω to 200 k Ω . To keep excellent V_O regulation, it is necessary to set I_{SHORT} 1.6 times greater than the maximum desired application I_O . When I_O reaches I_{SHORT} – 300 mA, the current limitor overrules regulation and V_O starts to drop and OCM flag is risen. When no current limitation adjustment is required, I_{SC} pin shall be left unbiased (as it is in 3 pin packages).

5.5 OCM pin

Goes low when current limitor starts to be active, otherwise $V_{OCM} = V$ (+). It is bufferized and can sink 10 mA. OCM pin is internally pulled-up by a 50 k Ω resistor. Can left open when V (+) = 0.

RHFL7913A Device description

5.6 Alternates to

RHFL7913A is recommended to replace all industry negative regulators due to its exceptional radiation performances. To replace 3-terminal industry devices, use customized RHFL7913 fixed voltage versions.

6 Application information

Adjusting output voltage: R1 resistor must be connected between $V_{\rm O}$ and ADJ pins. R2 resistor must be connected between ADJ and GND pins. Resistor values can be derived from the following formula:

$$V_O = V_{ADJ} (1 + R1/R2)$$
 with $V_{ADJ} = -1.20 \text{ V}$

To access all RHFL7913A adjustable functionality, V (+) shall be set at 3.0 V (max 5 V). As a consequence, V_{I} (-) cannot be greater than -9.0 V (resp. -7 V) due to -12 V maximum operation rating.

The device is functional as soon as V_I - V_O voltage difference is slightly above power element saturation voltage. The adjustable pin to Ground resistor shall not be greater than 10 k Ω to make output feedback error be below 0.2%. A minimum 0.5 mA I_O is necessary to set to ensure perfect "no-load" regulation. It can be wise to dissipate this current into the divider bridge resistor.

All available V_I pins shall always be PCB interconnected, the same for all available V_O pins, otherwise device stability and reliability cannot be granted. The INHIBIT function switches off output current in an electronic way, is very quickly. According to Lenz' Law, external circuitry reacts with –Ldl/dt terms which can be of high amplitude in case some series-inductance exists. Effect would be large transient voltage developed on both device terminals. External Schottky diodes set on V_I and V_O may prevent voltage excursions beyond max ratings. In the worst case, a 14 V Zener diode shall protect the device input. In case of capacitive load, a input-output protection diode can be necessary to prevent V_O to be greater than V_I during transient operation.

The device has been designed for high stability and low drop out operation: minimum 1 μ F input and output tantalum capacitors are therefore mandatory. Typical industry PCB design practices 10 μ F capacitors values are acceptable. Capacitor ESR range is from 0.020 Ω to over 20 Ω . Such range turns out to be useful when ESR increases at low temperature. When large transient currents are expected, larger value capacitors are necessary.

In case of high current operation with expected short-circuit events, caution shall be considered relatively to capacitors. They shall be connected as close as possible form device terminals. As some tantalum capacitors may permanently fail when submitted to high charge-up surge currents, it is recommended to decouple them with 470 nF polyester or ceramic capacitors.

RHFL7913A adjustable being manufactured with very high speed bipolar technology (6 GHz f_{T} transistors), the PCB layout shall be performed with unprecedented care, very low inductance, low mutually coupling lines, otherwise high frequency parasitic signals may be picked-up by the Device resulting into system self-oscillation. In difficult high current circumstances (coming from PCB layout) a 470 nF polyester capacitor connected between V_{O} and ADJ pin increases stability margins. Benefit is SVR performances extended to far higher frequencies.

6.1 Remote sensing operation

When load is physically far away from device output, the adjustable line can be set as a kelvin sense—line by implementing the divider resistor bridge as close as possible form device, with a decoupling capacitor. The adjust pin kelvin sense line (to be not coupled with power line) picks-up load voltage (load also locally decoupled with a capacitor). This layout eliminates ohmic drop in load power wire. Similarly, by taking advantage of two separate ground terminals: power ground pin shall be directly connected to load ground terminal which is also the system ground, device signal ground shall be separately connected to load ground terminal by another kelvin line: In this way, ground ohmic errors are minimized because the only current flowing into device signal ground pin kelvin line is device Iq (a matter of a few mA).

Die information RHFL7913A

7 Die information

RHFL7913A adjustable is also available in die form. Space dice are electrically tested by STMicroelectronics in such a way that, when mounted in proper thermal and electrical substrate, they are in full compliance with equivalent packaged device:

DIE physical dimensions.

DIE size: 110 mils x 166 mils

DIE thickness: 375 μ m +/-25 μ m (14.8 mils +/- 1 mil)

Pad size:

 V_I , V_O pads: 245 μ m x 544 μ m Control pads: 184 μ m x 184 μ m

Interface materials

Top Metallization: Al/Si/Cu 1.05 μm +/- 0.15 μm

Backside metallization: None

Glassivation

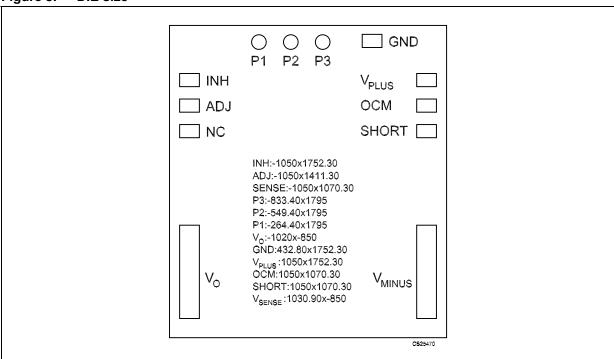
Type: P.Vapox + Nitride

Thickness: $0.6 \mu m +/- 0.1 \mu m + 0.6 \mu m +/-0.08 \mu m$

Substrate: Silicon (connected to $V_I = V_{minus}$)

The SENSE pad is layout on the die but is not electrically connected to the IC and shall be left non-bonded during hybrid bonding.

Figure 3. DIE size

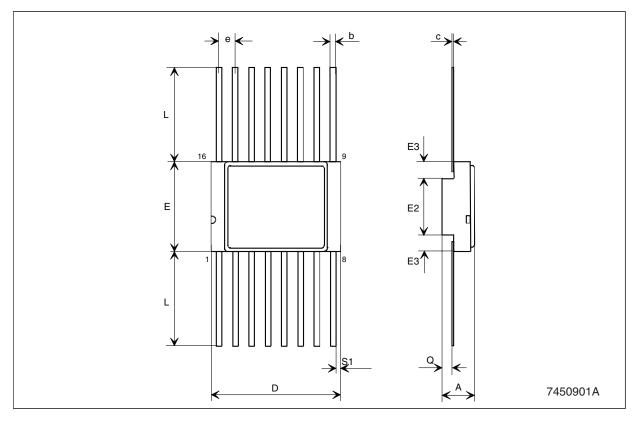


8 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

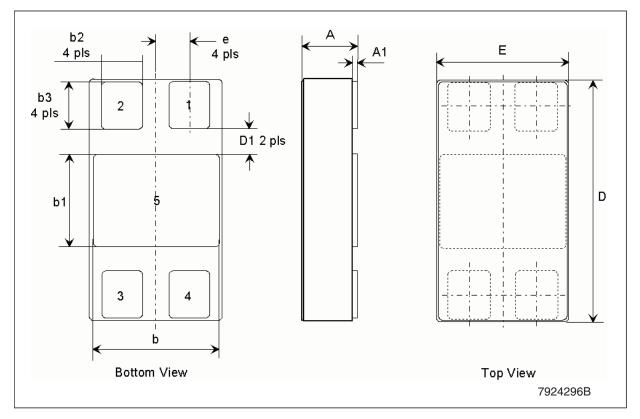
FLAT-16 (MIL-STD-1835) mechanical data

Dim.	mm.					
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	2.16		2.72	0.085		0.107
b		0.43			0.017	
С		0.13			0.005	
D		9.91			0.390	
E		6.91			0.272	
E2		4.32			0.170	
E3	0.76			0.030		
е		1.27			0.050	
L		6.72			0.265	
Q	0.66		1.14	0.026		0.045
S1	0.13			0.005		



SMD5C mechanical data

Dim.	mm.			inch.		
Dilli.	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	2.84	3.00	3.15	0.112	0.118	0.124
A1	0.25	0.38	0.51	0.010	0.015	0.020
b	7.13	7.26	7.39	0.281	0.286	0.291
b1	4.95	5.08	5.21	0.195	0.200	0.205
b2	2.28	2.41	2.54	0.090	0.095	0.100
b3	2.92	3.05	3.18	0.115	0.120	0.125
D	13.71	13.84	13.97	0.540	0.545	0.550
D1	0.76			0.030		
E	7.39	7.52	7.65	0.291	0.296	0.301
е		1.91			0.075	



Packaging RHFL7913A

9 Packaging

RHFL7913A adjustable is available in high thermal dissipation 16 pin hermetic FLAT package, which bottom flange is metallized to allow direct soldering to heat sink (efficient thermal conductivity). It is also available in SMD5C hermetic ceramic package.

RHFL7913A Order codes

10 Order codes

Table 6. Order codes

Die	FLAT-16	SMD5C	Terminal finish	Quality level
	RHFL7913KPA1		GOLD	EM1
	RHFL7913KPA2		GOLD	EM2= EM1 + 48hours BI
	RHFL7913KPA-01V		GOLD	QML-V
	RHFL7913KPA-02V		SOLDER	QML-V
		RHFL7913SCA1	GOLD	EM1
		RHFL7913SCA2	GOLD	EM2= EM1 + 48hours BI
		RHFL7913SCA-03V	GOLD	
L7913ADIE2S				EM1 die
L7913ADIE2V				QML-V

EM1: Engineering parts, full temperature range, flight packages, no burn-in

EM2: Same as above but with burn-in, used in Satellite EQMs

Table 7. Part number - SMD equivalent

ST part number	SMD part number
RHFL7913KPA-01V	5962F0253201VXC
RHFL7913KPA-02V	5962F0253201VXA
RHFL7913SCA-03V	5962F0253202VYC
L7913ADIE2V	5962F0253201V9A

Table 8. Environmental characteristics

Parameter	Conditions	Value	Unit
Output voltage thermal drift	-55 °C to +125 °C	40	ppm/°C
Output voltage radiation drift	From 0 kRad to 300k Rad at 0.55rd/sec	8	ppm/krad
Output voltage radiation drift	From 0 kRad to 300 kRad, MIL1019.5	6	ppm/krad

Note:

Revision history RHFL7913A

11 Revision history

Table 9. Document revision history

Date	Revision	Changes
16-May-2006	1	First release.
22-Aug-2006	2	The pin description for SMD5C on table 1 updated.
19-Dec-2007	3	Modified: <i>Table 6</i> .
26-Aug-2008	4	Modified: Features on page 1, Table 1 on page 4, the V _I value Table 4 on page 5, Table 5 on page 6 and Section 6 on page 10.

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time. without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2008 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

